SDAS034C - APRIL 1982 - REVISED FEBRUARY 2009

 Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

description

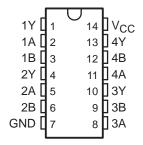
These devices contain four independent 2-input positive-NOR buffers with open-collector outputs. Open-collector outputs require resistive pullup to perform correctly. They can deliver higher V_{OH} levels and commonly are used in wired-AND applications. These devices perform the Boolean functions $Y = \overline{A} \bullet \overline{B}$ or $Y = \overline{A} + \overline{B}$ in positive logic.

The SN54ALS33A is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ALS33A is characterized for operation from 0°C to 70°C.

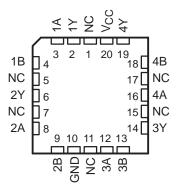
FUNCTION TABLE (each gate)

INP	UTS	OUTPUT
Α	В	Υ
Н	Χ	L
X	Н	L
L	L	Н

SN54ALS33A . . . J PACKAGE SN74ALS33A . . . D OR N PACKAGE (TOP VIEW)



SN54ALS33A . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

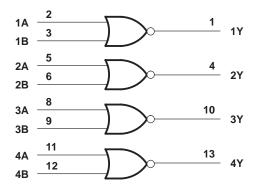
logic symbol†

4.6	2	≥1▷	1 1	
1A 1B	3	≥1▷ ♦	<u>'</u>	1Y
2A	5		4	
2A 2B	6		-	2Y
2B 3A	8		10	
3A	9		10	3Y
3B 4A	11			
	12		13	4Y
4B			J	

[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for the D, J, and N packages.

logic diagram (positive logic)





SN54ALS33A, SN74ALS33A QUADRUPLE 2-INPUT POSITIVE-NOR BUFFERS WITH OPEN-COLLECTOR OUTPUTS

SDAS034C - APRIL 1982 - REVISED FEBRUARY 2009

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Input voltage, V _I		7 V
Off-state output voltage		7 V
Operating free-air temperature range, T _A :	SN54ALS33A	-55°C to 125°C
	SN74ALS33A	0°C to 70°C
Storage temperature range		-65°C to 150°C

recommended operating conditions

		SN54ALS33A			SN			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.7			0.8	V
Vон	High-level output voltage			5.5			5.5	V
lOL	Low-level output current			12			24	mA
TA	Operating free-air temperature	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

24244555		SN54ALS33A			SN74ALS33A				
PARAMETER]	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT	
V _{IK}	$V_{CC} = 4.5 \text{ V},$	$I_{I} = -18 \text{ mA}$			-1.5			-1.5	V
V _{OL}	V 45V	I _{OL} = 12 mA		0.25	0.4		0.25	0.4	.,
	V _{CC} = 4.5 V	I _{OL} = 24 mA					0.35	0.5	V
lį	$V_{CC} = 5.5 \text{ V},$	V _I = 7 V			0.1			0.1	mA
lіН	$V_{CC} = 5.5 \text{ V},$	V _I = 2.7 V			20			20	μΑ
I _{IL}	V _{CC} = 5.5 V,	V _I = 0.4 V			-0.1			-0.1	mA
ЮН	$V_{CC} = 4.5 \text{ V},$	$V_{OH} = 5.5 V$			0.1			0.1	mA
Іссн	$V_{CC} = 5.5 \text{ V},$	V _I = 0		1.7	2.8		1.7	2.8	mA
ICCL	$V_{CC} = 5.5 \text{ V},$	V _I = 4.5 V	·	5.6	9		5.6	9	mA

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

switching characteristics (see Figure 1)

3	J ,						
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _C C _L R _L T _A SN54A	UNIT			
			MIN	MAX	MIN	MAX	
^t PLH	A or B		10	59	10	33	200
t _{PHL}	AOIB	T T	2	18	2	12	ns

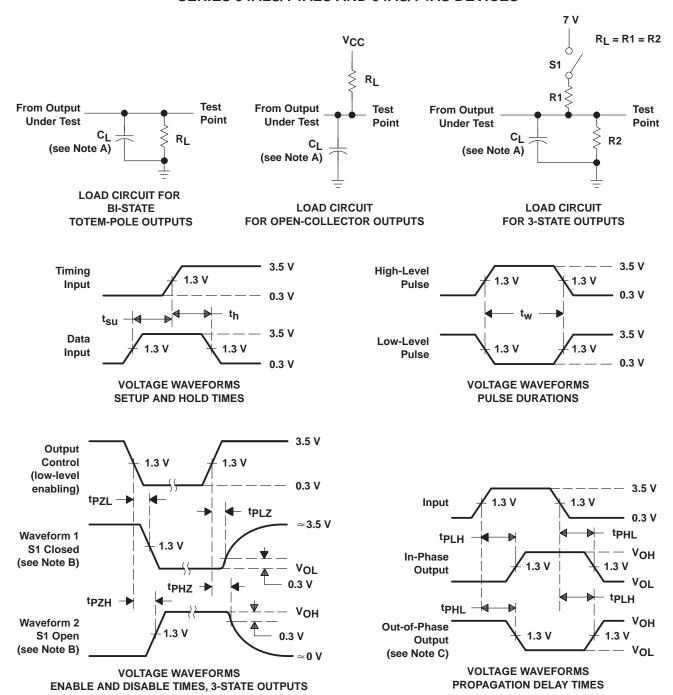
[§] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

SDAS034C - APRIL 1982 - REVISED FEBRUARY 2009

PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR \leq 1 MHz, $t_r = t_f = 2$ ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



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PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing		Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN54ALS33AJ	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54ALS33AJ	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

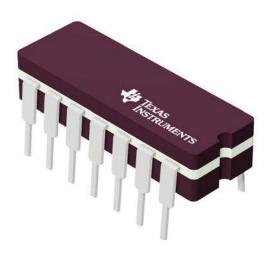
Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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CERAMIC DUAL IN LINE PACKAGE



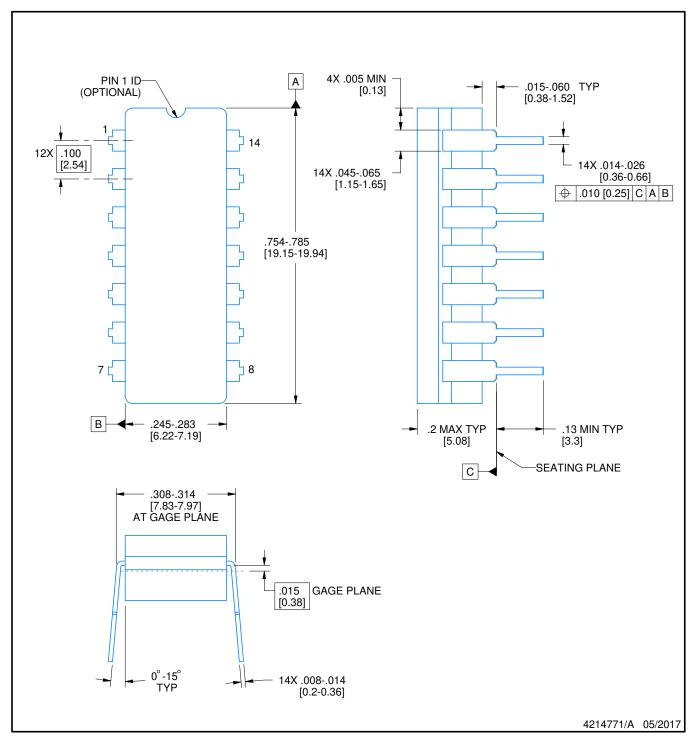
Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4040083-5/G





CERAMIC DUAL IN LINE PACKAGE

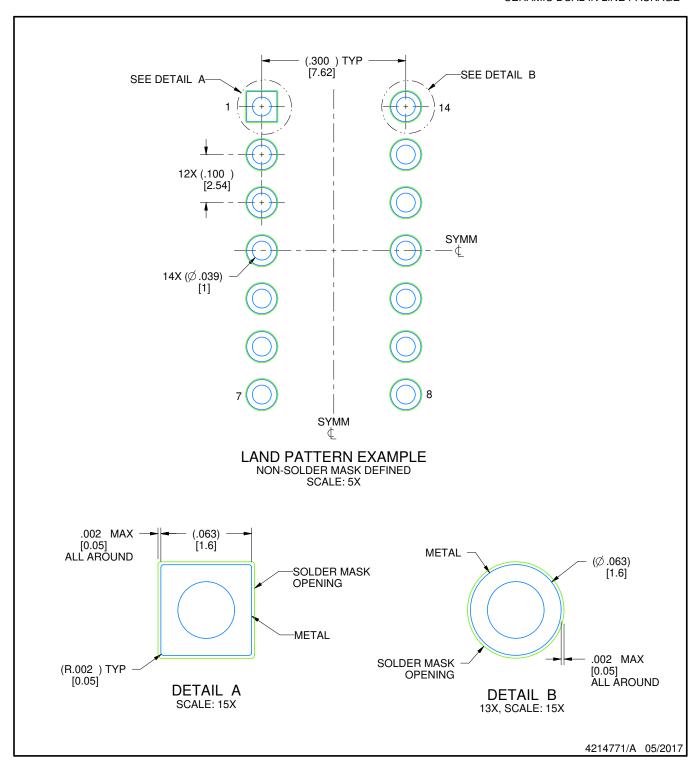


NOTES:

- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- His package is remitted by sealed with a certain is using glass int.
 Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
 Falls within MIL-STD-1835 and GDIP1-T14.



CERAMIC DUAL IN LINE PACKAGE



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